GMSLE FDD PHY SIMULATION RESULTS AND PHY COMPLEXITY

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Outline



- ► Objective
- ► GMLSE Baseline
- ► DME Noise Analysis
 - Receiver/Test Setup
 - CW Noise Simulation Results
 - Burst Noise Simulation Results
- ▶ Power Over Coax (POC) with GMSLE
 - POC Qualification
 - "Mystery" POC with GMSLE
- Complexity Revisited
 - Detailed Camera Complexity Analysis
- Conclusion



- Show performance results for GMSLE DME Upstream receiver in presence of automotive noise
- Present POC testing methodology and reveal 'mystery' POC
- Revisit camera-side complexity analysis
 - Provide detailed analysis on digital and analog blocks for GMSLE and TDD-based camera PHYs
 - Provide more detail on host-side complexity

GMSLE FDD SerDes Baseline



Ethernet MAC Interface		XGMII							
Line Coding		64B/65B encoding (see detail, next slide)							
Duplexing		FDD (Echo Subtraction/Partial Echo Cancellation possible)							
Link Rates and Modulation		Forward Link: 2.5Gbps NRZ, 5Gbps NRZ, 5Gbps PAM4 (option) ,10Gbps PAM4 Reverse Link: 100Mbps							
Scrambler		Downstream: 1+x ¹³ +x ³³ Upstream: 1+x ²⁰ +x ³³							
PHY Transmit Parameters		Rate	Mod	Encoding	FEC RS(n,k)	Baud Rate	TX Power	Burst Noise Protection	
	Downstream high-speed link rate:	2.5Gbps 5Gbps 5Gbps 10Gbps	NRZ NRZ PAM4 PAM4	15x65b+1 bit OAM 2x(15x65b+1b OAM) 2x(15x65b+1b OAM) 4x(15x65b+1b OAM)	RS(144,122) L=1 m=8 RS(144,122) L=2 m=8 RS(144,122) L=2 m=8 RS(144,122) L=4 m=8	2.5Gbps:3GBaud5Gbps:6GBaud5Gbps:3GBaud10Gbps:6GBaud	-0.76dBm -0.76dBm -1.76dBm -1.76dBm	88 PAM-2 symbols, 29.3ns 176 PAM-2 symbols, 29.3ns 88 PAM-4 symbols, 29.3ns 176 PAM-4 symbols, 29.3ns	
	Upstream low- speed link rate:	100Mbps	DME	3x65b+13bit OAM	RS(30,26) L=1 m=8	100Mbps: 250MHz	-5dBm	16 DME Symbols, 64ns	
Low complexity POC		Yes, single inductor, also compact dual inductor							
XTAL-less Camera PHY?		Yes, supported							

Upstream Low Speed Direction Noise Considerations



- ▶ EMI tolerance is a critical issue for automotive PHYs
- GMSLE Upstream PSD is within ISO 11452-4 Part 4 Bulk Current Injection (BCI) frequency range



Pischl contribution [1] shows EMC measurements for BCI clamp on coax for DUT grounded and floating conditions with 200mA test level



Evaluate possible low complexity GMSLE DME receiver implementation with respect to 355mA BCI test level measurements (scale Pischl DUT GNDed and float results 1.78x)

Possible GMSLE DME Matched Filter Receiver



- A matched filter receiver [3] for DME [2] is one possible receiver implementation for the GMSLE upstream (low-speed data rate) direction
- ▶ Evaluate a comparator matched filter with CW noise.
 - Very similar to William Lo's contribution [4]



DME Noise Simulation Setup

- ▶ Upstream Low-speed TX
 - Power: -5dBm for FM band EMC compatibility
 - TX Rate: 250Mbaud
 - TX filtering 2nd order Butterworth, fc=275MHz
- Downstream High-speed TX
 - Power: -0.76dBm
 - TX Rate: 3Gbps NRZ
- Packets
 - 100e5 packets per 500kHz step
 - Random packet payload with 1+x²⁰+x³³ scrambler applied
- Channel
 - 15.5m harness:
 - 2 inductor POC biased at 400mA, 33MHz POC HPF Corner (both sides)
 - 0.5m+5m+10m link segment RTK031-type cable
 - 13.5m harness:
 - Mystery POC, biased at 400mA, 33MHz POC HPF corner (both sides)
 - 0.5m+13m RTK031-type cable

- AWGN
 - Inject -25dBc just before receiver
- CW interference
 - Inject from 1-400 MHz CW with pi/2 offset in 500kHz steps
 - Start at 250mV peak and reduce until passing
- Hybrid
 - Active hybrid -24dB
- Upstream Low-speed Receiver
 - RX Filtering:
 - 2nd order Butterworth LPF, fc=275MHz
 - Matched filter (see previous page)
- ▶ Criteria
 - Dwell CW noise at each frequency
 - Pass criteria: 0 Pre-FEC errors, reduce TX power and rerun until pass at each frequency

DME Receiver CW Noise Simulation Results

▶ GMSLE DME MF receiver meets 355mA BCI test level-equivalent noise with margin at -5dBm transmit level

- A mixed-signal single-bit matched filter receiver meets requirements with low complexity
- Multi-bit matched filter, higher OSR, give higher performance and may be used but are not required
- GMSLE Upstream low data rate transmit level of -5dBm keeps spectral energy in FM band low

POC Qualification Process Test Setup

2-port VNA for IL & RL measurement

View from VNA going into Oven DC power supply and Electronic Load (bias) PoC coupon boards inside oven chamber

POC Coupon Board Example

Mystery Revealed: Single Inductor POC with GMSLE

-15

-20

-25

-30

-35

Channel with POC

0.5

5G(NRZ)/10G(PAM4) Spec

5G(NR7)/5G(PAM4) She

2.5

Frequency (Hz)

3

3.5

 $\times 10^9$

B

- Single inductor POC solution measured at 600mA load current:
 - Short channel 0.5m RTK031-type cable + 2xPOC at 105C (RL worst case)
 - Long channel 13.5m RTK031 with 2xPOC at 105C (IL worst case)

Single Inductor POC Considerations

- Single inductor POC solutions are available today which meet RL and IL specifications for PAM4 limits with margin in worst-case conditions
 - With GMSLE, a more compact single inductor POC solution than GMSL3/2 can be used, due to upstream DME modulation. More low frequency return loss is allowed
 - For low-cost 3MP and 5MP applications, relaxing RL requirements at high frequencies and IL to the proposed limit line can further reduce the size of POC inductor for these applications

Complexity Revisited: Detailed Camera Analysis

- ▶ For widespread adoption of 802.3dm, reducing camera PHY complexity is paramount
 - GMSLE takes advantage of asymmetrical data rates
 - Reduce receive complexity for the low rate receiver on one side of the link
 - TDD by contrast needs to implement a full speed receiver on both sides of the link
- Build on analysis of Lo[4] and Houck[5]
- Compare GMSLE PHY with TDD PHY
 - Starting point: ASA PHY and GMSL3/2 PHYs in same geometry
 - Make allowances for changes for GMSLE and TDD:
 - No OAM root/leaf node command overhead in TDD vs. ASA
 - Adjust FEC (ASA->TDD-proposed; GMSL->GMSLE-proposed)
- Digital
 - TDD estimated at **26% more** NAND gate equivalent digital area^ primarily in these areas:
 - Least Mean Squared (LMS) or other adaptive alg. vs. none in GMSLE
 - Adaptation for TDD CTLE + DFE* vs. matched filter in GMSLE
 - RS-FEC
 - TDD: (130,122) t=4 vs. GMSLE: (30,26) t=2
 - FEC Decoder complexity + 130 vs 30 symbol buffer storage
 - Additional FIFOs in TDD

^after Post-shrink of 10% and considering 60% utilization for both

* A DFE is a very good idea at 3GBaud

	Approx. Extra relative Digital Area
Adaptation/LMS	+12.6%
RS-FEC difference	+11.9%
Additional FIFOs + misc	+1.5%
Total:	+26%

Detailed Camera Complexity Analysis

- ► Analog
 - TDD estimated at 250% more analog area primarily in these areas:
 - TDD: High-speed 3Gbps CTLE+DFE receiver vs. GMSLE hybrid + DME matched filter
 TDD: 245% more area
 - CDR, 4%
 - Power management, 1%

- ▶ Integration
 - 26% increase in digital complexity is significant
 - Camera nodes will stay with 22nm and even 40nm processes for foreseeable future
 - 250% increase in analog complexity is extremely significant and scales less with process
 - TDD increased complexity translates to larger die area and higher cost

Relative Complexity Analysis, Camera PHY Revisited

	GMSLE	ACT	TDD
Camera Downstream highspeed TX Complexity	Least complex Lower PAPR (NRZ) 2.5Gbps NRZ, 5Gbps NRZ opt.	Slightly more complex Higher PAPR (2.5 & 5Gbps vs NRZ) PAM4 @ 2.5 & 5Gbps	More complexTDD > 1.5% Digital
Camera Upstream lowspeed RX Complexity	Much Less Complex Analog Matched Filter No EQ Required 	Much Less Complex Analog Matched Filter No EQ Required 	Much more complex TDD >250% Analog Equalization > 24.5% Digital
Camera Power Consumption	Lowest	Lowest	Highest, Higher Peak PowerTDDEqualization
Camera LS RX FEC	n=30,k=26, m=8, t=2	n=50, k=46, m=6, t=2	n=130, k=122, m=8, t=4
Camera LS RX FEC decoder area complexity^	1.0x 1 symbol/clock impl @125MHz	0.71x 1 syml/clk @117.1875 MHz	2.66x Much more complex
Upstream burst protection	64ns	51.2ns less than GMSLE	10.6ns much less than GMSLE
Crystal-less Camera Serializer	Simple Mass production (GMSL) 	Simple	Possible, but more Complex
Upstream latency (including FEC)	8µs	Similar to GMSLE (est)	~9.6µs (est., based on [2])
Summary	 Lowest PAPR (NRZ modes) Lowest Complexity for 3MP 2.5Gbps and 8Mp 5Gbps cameras Highest burst protection 	Slightly higher PAPR Low Complexity	Highest complexity. Raises cost, power for 3MP 2.5Gbps and 8MP 5Gbps cameras. XTAL-less more complex. Lower burst protection margin with > 2x the complexity

^equivalent area of num 2 input NAND gates + 2-port memory in same geometry ^^ (floor((n-k)/2)*m)/Baud

Relative Complexity Analysis, HS RX, LS TX PHY

	GMSLE	ACT	TDD
POC	Small, single inductor, proven	Small, single inductor	Smallest, single inductor
Downstream HS Receiver Complexity	 Least complex More Euclidean dist. @2.5 Gbps & 5Gbps PAM2 mode Analog or Digital EQ OK 	 Most complex Less Euclidean distance @2.5 & 5 Gbps Long digital FFE + 1-tap MLSE or DFE (or DFFE) 	More complex TDD 200%
Downstream HS FEC	n=144,k=122, m=8, t=11	n=360,k=326, m=10, t=17	n=130,k=122, m=8, t=4
Downstream HS RX FEC Correctable burst length ^^	29.3ns (L=1,2,4)	60.4ns (L=1,2,4 in 2.5/5/10Gbps)	10.6ns (L=1,2,4)
Downstream HS RX FEC Decoder Area Complexity^	1.0x	1.6x	0.66x
Downstream Latency (including FEC)	2.5Gbps: 2.75µs 5Gbps: 1.8µs (L=2) 10Gbps: <2µs (L=4)	2.5Gbps: 4.096µs^^^ 5 Gbps: 2.764µs (L=2) 10Gbps: 2.048µs (L=4)	Claimed 1µs from [2]
Downstream Summary	Lowest complexity Analog or digital EQ OK	Higher complexity Digital ADC and EQ required	High Complexity, TDD Lower burst noise protection
Reliability (DFMEA)	Proven (GMSL)	Limited volume	Not proven
Units Shipped	Base architecture (GMSL): > 1.1 Billion links	Base architecture (802.3ch): 100k (est.)	(ASA) <mark>0</mark>

[^]equivalent 2 input NAND gates area + two port memory area in same geometry. 750MHz clock in all designs ^{^^} from 802.3 clause 149 table 149-20

Conclusion

- This presentation has shown GMSLE complexity is lower than proposed TDD and ACT solutions
 - GMSLE DME Upstream Low-speed link operates with margin over automotive noise conditions with low complexity
 - Single inductor POC solutions are available for FDD, today
 - Relaxed RL requirements at low frequency for GMSLE enable even more compact 1 inductor POC

▶ GMSLE complexity is less than TDD at the camera and less than ACT at a host PHY

- GMSLE offers an appropriate level of complexity for the channel and meets Task Force Objectives
- Future contributions, Downstream high-speed receiver noise measurements and cable considerations, will be presented
- Looking to collaborate and build consensus in the Task Force

[1] BCI-Induced Noise Ingres to Coaxial MDI Test Method and Measured Levels, N Pischl, and M Tazebay, <u>https://www.ieee802.org/3/dm/public/1124/Pischl_3dm_01a_1124.pdf</u>

[2] Proposed Preamble: Synchronization and Harness Defect Detectio, J Cordaro, <u>https://www.ieee802.org/3/cg/public/adhoc/cordaro_3cg_06_0418.pdf</u> pp 19-21

[3] B Sklar, and f harris, Digital Communications Fundamentals and Applications, 3rd Edition. New York: Pearson Education, Inc, 2021 pp 117–121

[4] Upstream Receiver, W Lo, https://www.ieee802.org/3/dm/public/0125/Lo_3dm_02a_0125.pdf

[5] Exploring Receiver Tradeoffs: 100Mbps and 3Gbps Implementations, TJ Houck, <u>https://www.ieee802.org/3/dm/public/0125/Houck_3dm_01_0121_5.pdf</u>